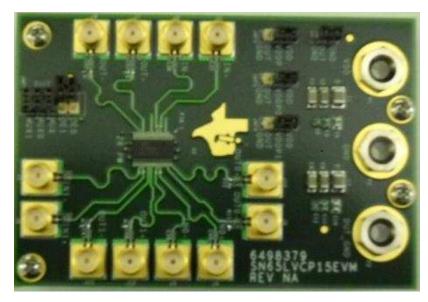


# SN65LVCP15 Evaluation Module (EVM)

The Texas Instruments SN65LVCP15 evaluation module (EVM) board is used to evaluate the SN65LVCP15 high performance serial link replicator for applications in Fibre Channel (1.0625 Gbps), Gigabit Ethernet (1.25 Gbps), HDTV (1.485 Gbps), and SATA (1.5 Gbps). The board enables the system designer to connect  $50-\Omega$  coax cables via SMA connectors.



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# 1 Introduction

The TI SN65LVCP15 evaluation module (EVM) is used to evaluate the SN65LVCP15 high performance serial Link Replicator for applications in Fibre Channel (1.0625 Gbps), Gigabit Ethernet (1.25 Gbps), HDTV (1.485 Gbps), and SATA (1.5 Gbps). The board enables the system designer to connect 50-Ω coax cables via SMA connectors. A serializer/deserializer (SerDes), such as the TLK2201B, would normally be connected to the IN± and OUT± ports in order to provide duplicate links on the IN0/OUT0 and IN1/OUT1 ports. A popular application is in line cards that use serial links from a SerDes-like TLK2201B where the SN65LVCP15 provides redundant, hot-swappable links to redundant switch fabric cards. Another common application is in host adapters which require an internal and an external connector where the SN65LVCP15 steers serial data between the SerDes and the two connectors. The board can be used to evaluate the device parameters while acting as a guide for high-speed board layout. The evaluation board can be used as a daughter board that is plugged into the new or existing designs. Additionally, the designer may wish to use buried transmission lines and provide additional noise attenuation and EMI suppression to optimize the end product.

As the frequency of operation increases, the board designer must take special care to ensure that the highest signal integrity is maintained. To achieve this, the board's impedance is controlled to 50  $\Omega$  for the high-speed differential connections. In addition, board impedance mismatches are reduced by designing the component pad size to be as close as possible to the width of the connecting transmission lines. Vias are minimized and, when necessary, placed as close as possible to the device drivers. Care was taken to control both impedance and trace-length mismatch (board skew) to less than ±1 MIL.

Overall, the board layout is designed and optimized to support high-speed operation. Thus, understanding impedance control and transmission-line effects is crucial when designing a high-speed board.

Some of the advanced features offered by this board include:

- Printed-circuit board (PCB) is designed for high-speed signal integrity.
- SMA fixtures are easily connected to test equipment.
- All input/output signals are accessible for rapid prototyping.
- Independent or simultaneous control of the 4 power supplies
- Onboard capacitors provide AC coupling of high-speed signals.

# 2 SN65LVCP15 EVM Kit Contents

The SN65LVCP15 EVM kit contains the following:

- SN65LVCP15 EVM board
- SN65LVCP15 EVM User's Guide (this document)

# 3 SN65LVCP15 EVM Board Configuration

This EVM gives the developer various options for operation, many of which are jumper-selectable. Other options can be either soldered into the EVM or connected through input connectors.

Input and output differential pairs are available through the surface-mount SMA connectors J1–J12.

There are two power planes on the board. The first power plane is split between the three output power supplies (VDDP, VDDP0, VDDP1) while the second power plane is dedicated to the VDD supply. The power supplies can be independently controlled by removing the shunts from jumpers JMP2, JMP3 and JMP4 and placing power supplies between pins 2 and 3 on these jumpers. VDD is controlled through the banana jack P1 and should always have power supplied. Only one power supply is required if shunts are placed between pins 1 and 2 on jumpers JMP2, JMP3 and JMP4, thus tying all supplies to the VDD banana jack P1.

The board is normally delivered in a default configuration that only requires power and signals be applied. The SN65LVCP15 is shipped with jumpers for default operation. The default setup is for AC-coupled operation. Table 2 shows the default configuration.

3

Introduction



SN65LVCP15 EVM Board Configuration

Two different types of ground planes are available on the board. DUT GND (P2) is the device ground and should always be the power supply return path. GND (P3) can be used to operate the device in DC-coupled mode directly into an oscilloscope, if desired. If DC-coupled mode is required, all AC-coupling caps on the outputs (C43–C48) need to removed and replaced with shorts, (see Table 3). A power supply set to VDD – 2 V needs to be placed between GND and DUT GND allowing a ground offset to be setup such that the device output will see a VDD – 2 V across 50  $\Omega$ , relative to DUT GND. When AC-coupled mode is required, GND and DUT GND can be shorted together through the JMP5 header.

There are five control pins that are used to control the multiplexer functions as well as the output enables for outputs 0 and 1. These control pins are routed to a 0.1" pitch header block, JMP1. Table 1 contains JMP1 control settings. All of the control pins have a pull-up resistor of 4.7 k $\Omega$  which allows for a default state of "ON" if the shunt is not installed. Installing a shunt from the control pins to DUT GND sets the control to "OFF".

Designator	ON (Shunt Removed)	OFF (Shunt Installed)
OE0	Output OUT0 enabled	Output OUT0 disabled and will float HIGH
OE1	Output OUT1 enabled	Output OUT1 disabled and will float HIGH
MUX	Input IN0 selected	Input IN1 selected
MUX0	Input IN selected	Input IN0 selected
MUX1	Input IN selected	Input IN1 selected

Table 2. Default Board Configuration as Shipped

## Table 1. JMP1 Control Table

Designator	Function	Condition
JMP5	DUT GND and GND Bridge	Joins the DUT GND and GND planes
JMP2	VDD and VDDP Bridge	Joins the VDD and VDDP power planes
JMP3	VDD and VDDP0 Bridge	Joins the VDD and VDDP0 power planes
JMP4	VDD and VDDP1 Bridge	Joins the VDD and VDDP1 power planes
JMP1	OE0	Jumper uninstalled (logic 1) – enables output 0 driver
JMP1	OE1	Jumper uninstalled (logic 1) – enables output 1 driver
JMP1	MUX	Jumper installed (logic 0) – selects IN0 as the source of output OUT
JMP1	MUX0	Jumper installed (logic 0) – selects IN0 as the source of output OUT0
JMP1	MUX1	Jumper installed (logic 0) – selects IN as the source of output OUT1
C43 – C48	Output AC-Coupling Capacitors	These capacitors (normally installed) are provided to ac-couple the output signals
C38 – C42	Input AC-Coupling Capacitors	These capacitors (normally installed) are provided to ac-couple the input signals

## Table 3. Configuration Changes Necessary for DC-Coupling

Designator	Function	Condition
JMP5	DUT GND and GND Bridge	Remove shunt
C43 – C48	Output AC-Coupling Capacitors	Remove capacitors and install zero- $\Omega$ resistors
C38 – C42	Input AC-Coupling Capacitors	Remove capacitors and install zero-Ω resistors



Figure 1 illustrates the EVM configuration as shipped.

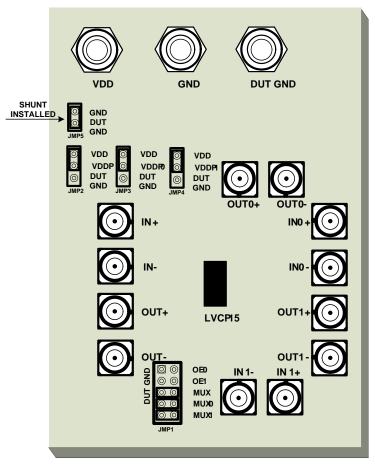


Figure 1. SN65LVCP15 EVM Configuration as Shipped



Power Supply Configurations

# 4 **Power Supply Configurations**

This section presents the power supply configuration used to evaluate and test the device. The PCB construction and characteristics are included in the second section of this section.

The following configurations are used to evaluate and test the SN65LVCP15. Figure 2 shows a standard AC-coupled test condition. Any generator and oscilloscope can be connected in this configuration.

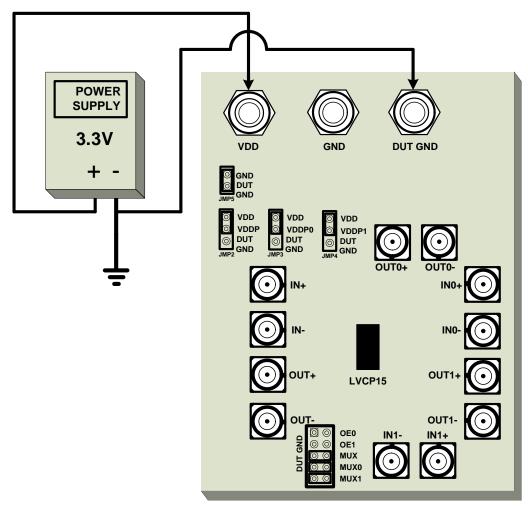


Figure 2. SN65LVCP15 AC-Coupled Power Supply Configuration



The configuration shown in Figure 3 shows how to connect the power supplies for DC-coupled testing. The power supplies **must be isolated power supplies**, both supplies must have the negative terminal not tied to earth ground.

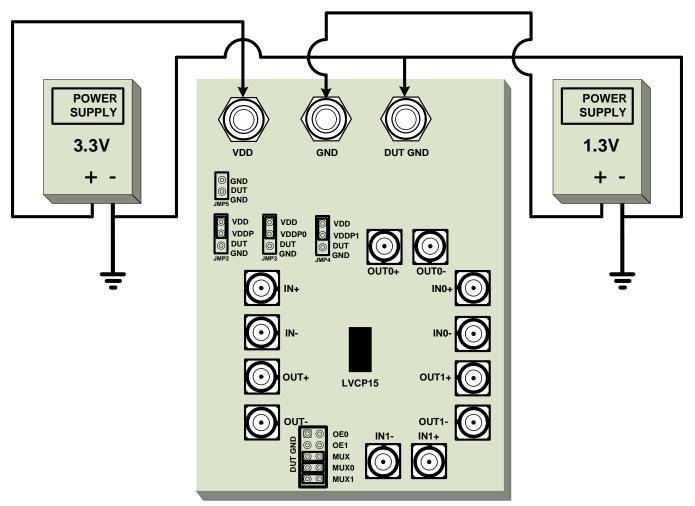


Figure 3. SN65LVCP15 DC-Coupled Power Supply Configuration



# 5 Schematics and Bill of Materials

This section contains the schematics and bill of materials (BOM) for this EVM.

# 5.1 Schematics

Figure 4 through Figure 7 illustrate the schematics for this EVM.

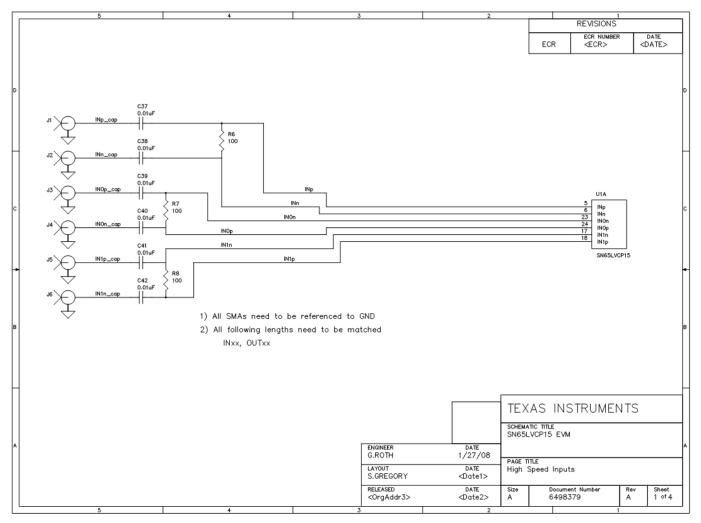
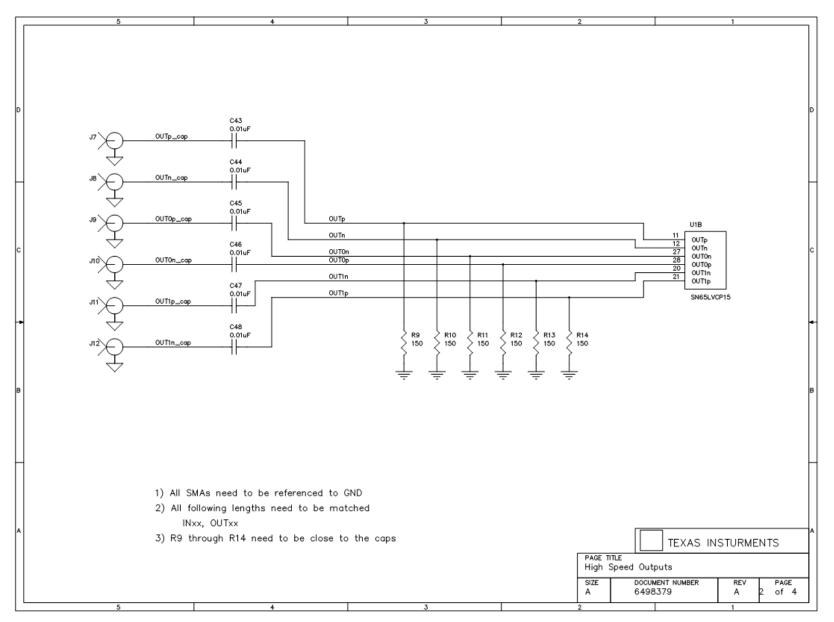


Figure 4. SN65LVCP15 Schematic: Inputs (1 of 4)



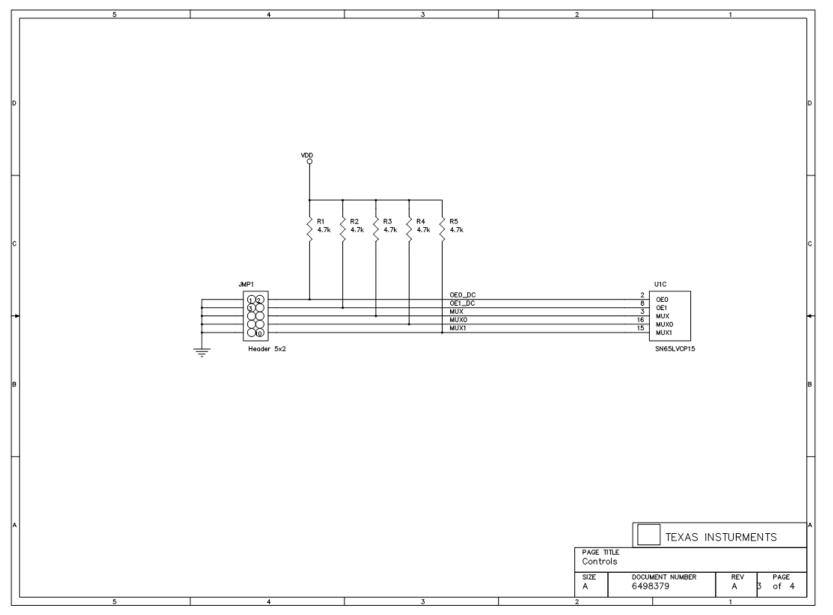


Schematics and Bill of Materials









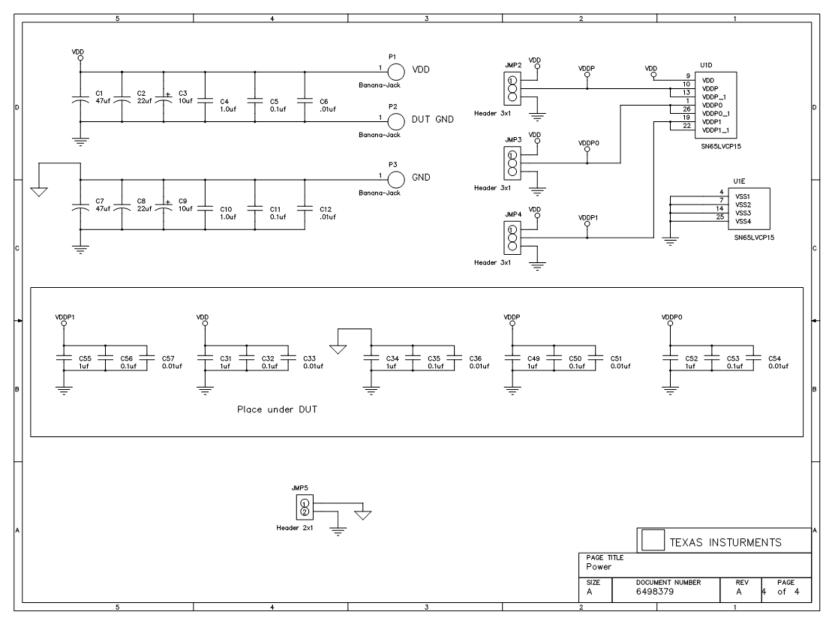








Schematics and Bill of Materials







Board Layout

## 5.2 Bill of Materials

The BOM for this EVM is shown in Table 4.

Item	Qty	Reference	Value	Part	Part Number	Manufacturer				
1	19	C6, C12, C33, C36, C51, C54, C57, C37– C48	0.01µF	cc0402	C0402X7R500-103KNE	Venkel				
2	5	C32, C35, C50, C53, C56	0.1µF	cc0402	C0402X7R160-104KNE	Venkel				
3	5	C31, C34, C49, C52, C55	1.0µF	cc0402	C0402X5R6R3-105KNE	Venkel				
4	2	C5, C11	0.1µF	cc0603	C0603X7R500-104KNE	Venkel				
5	2	C4, C10	1.0µF	cc0805	GRM21BR71H105KA12L	Murata Electronics North America				
6	2	C3, C9	10µF	cc1206	C1206X7R160-106KNE	Venkel				
7	2	C2, C8	22µF	cc1206	C1206X5R6R3-226KNE	Venkel				
8	2	C1, C7	47µF	cc1210	EMK325BJ476MM-T	Taiyo Yuden				
9	3	R6, R7, R8	100Ω	r0402	CR0402-16W-1000FT	Venkel				
10	6	R9–R14	150Ω	r0402	ERJ-2RKF1500X	Panasonic-Ecg				
11	5	R1–R5	4.75kΩ	r0603	CR0603-16W-4751FT	Venkel				
12	7		Shunt	0.1" sp	382811-6	Amp/Tyco				
13	1	JMP1	Header 5x2	0.1x0.1"	HTSW-150-08-G-D	Samtec				
14	1	JMP5	Header 2x1	0.1x0.1"	HTSW-150-08-G-D	Samtec				
15	3	JMP2–JMP4	Header 3x1	0.1x0.1"	HTSW-150-08-G-S	Samtec				
16	3	P1, P2, P3	Banana Jack	4mm	108-0740-001	Emerson Network Power				
17	12	J1–J12	32K141-40ML5	T/H_SMT SMA	32K141-40ML5	Rosenberger				
18	1	U1	SN65LVCP15	28PW	SN65LVCP15	Texas Instruments				

# Table 4. SN65LVCP15 EVM Bill of Materials

# 6 Board Layout

Table 5 contains the PCB layer construction information.

Subclass Name	Туре	Material	Thickness (MIL)	Conductivity (mho/cm)	Dielectric Constant	Loss Tangent	Artwork	Width (MIL)	Impedance (Ω)
	Surface	Air							
TOP	Conductor	Copper	2.4	595900	1	0	Positive	12	50.312
	Dielectric	FR-4	6.75	0	4.1	0.035			
L2_GND	Plane	Copper	1.2	595900	1	0	Positive		
	Dielectric	FR-4	5	0	4.1	0.035			
L3_VDD	Conductor	Copper	1.2	595900	1	0	Positive		
	Dielectric	FR-4	5	0	4.1	0.035			
L4_DUT_GND	Plane	Copper	1.2	595900	1	0	Positive		
	Dielectric	FR-4	20	0	4.1	0.035			
L5_DUT_GND	Conductor	Copper	1.2	595900	1	0	Positive		
	Dielectric	FR-4	5	0	4.1	0.035			
L6_VDD	Plane	Copper	1.2	595900	1	0	Positive		
	Dielectric	FR-4	5	0	4.1	0.035			
L7_GND	Plane	Copper	1.2	595900	1	0	Positive		
	Dielectric	FR-4	6.75	0	4.1	0.035			
BOTTOM	Conductor	Copper	2.4	595900	1	0	Positive	12	50.312
	Surface	Air							

# Table 5. SN65LVCP15 EVM PCB Layer Construction<sup>(1)</sup>

<sup>(1)</sup> Always consult with your board manufacturer for their process/design requirements to ensure the desired impedance is achieved.



Figure 8 through Figure 14 illustrate the PCB layers of this EVM.

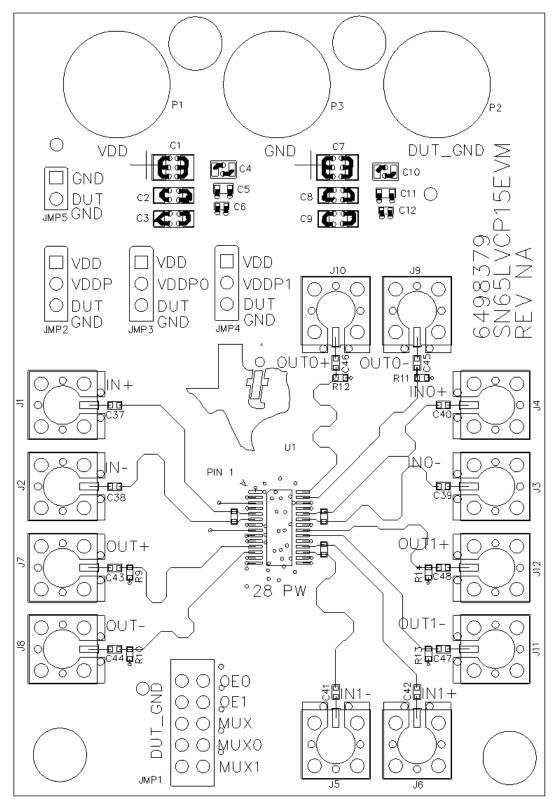


Figure 8. SN65LVCP15 Board Layout: Top (Layer 1)



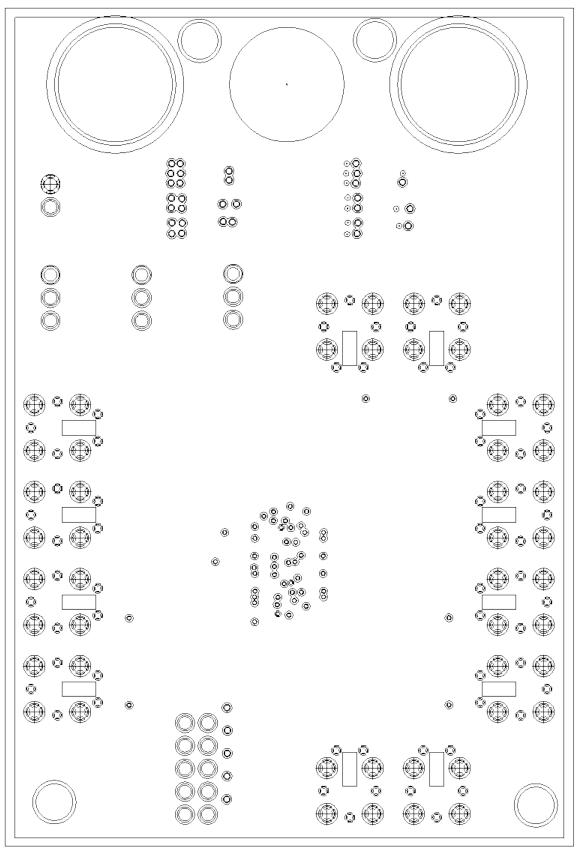


Figure 9. SN65LVCP15 Board Layout: GND (Layer 2)



Board Layout

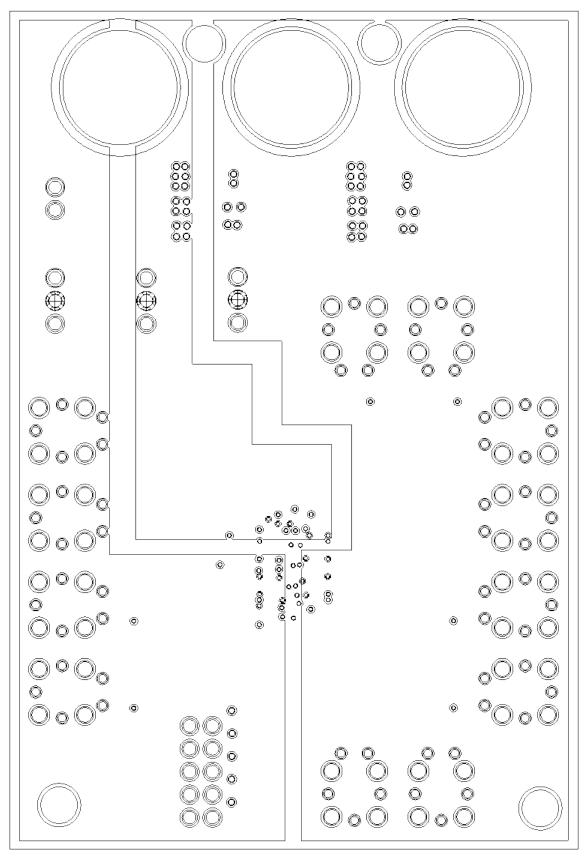


Figure 10. SN65LVCP15 EVM Board Layout: VDDP, VDDP0 and VDDP1 (Layer 3)



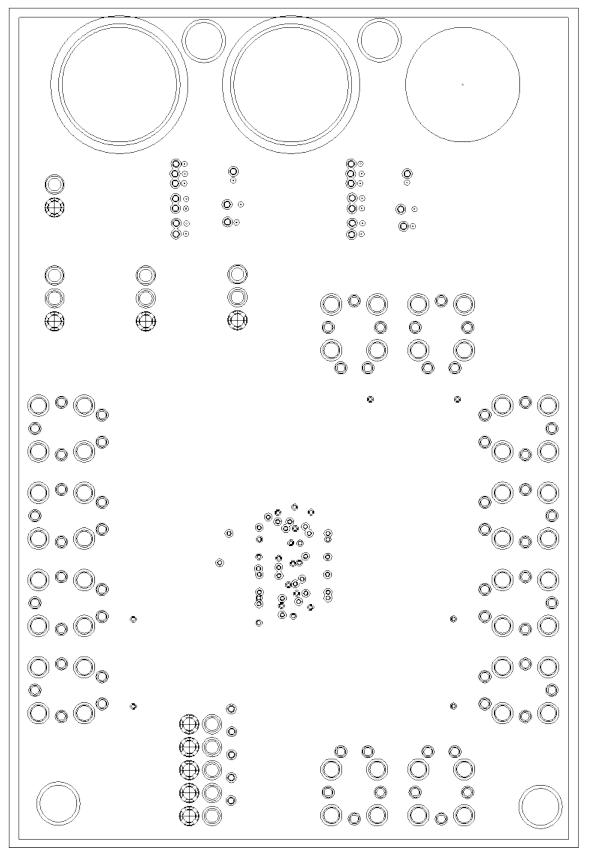


Figure 11. SN65LVCP15 Board Layout: DUT GND (Layers 4, 5)



Board Layout

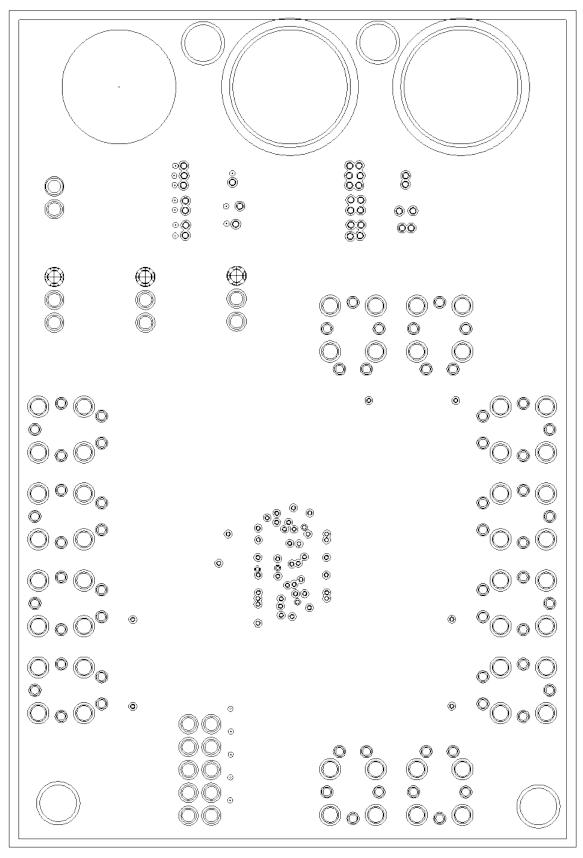


Figure 12. SN65LVCP15 Board Layout: VDD (Layer 6)



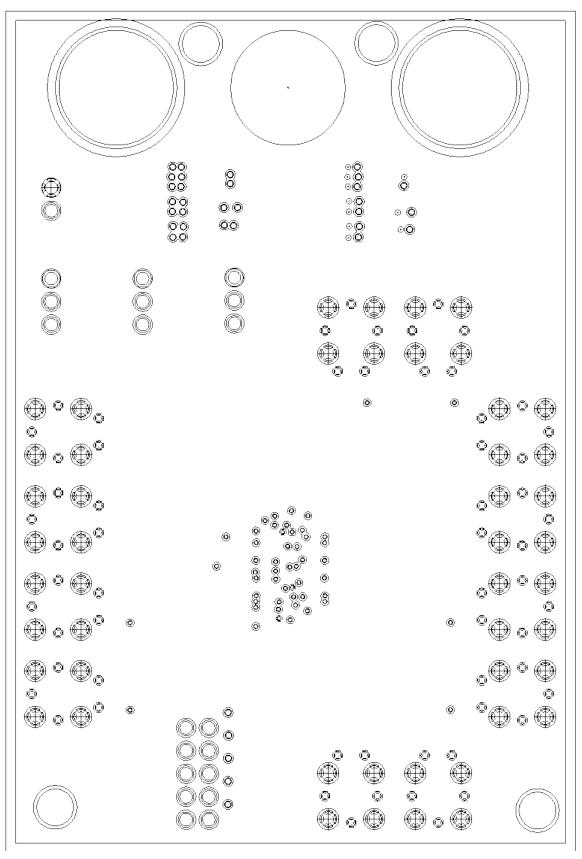
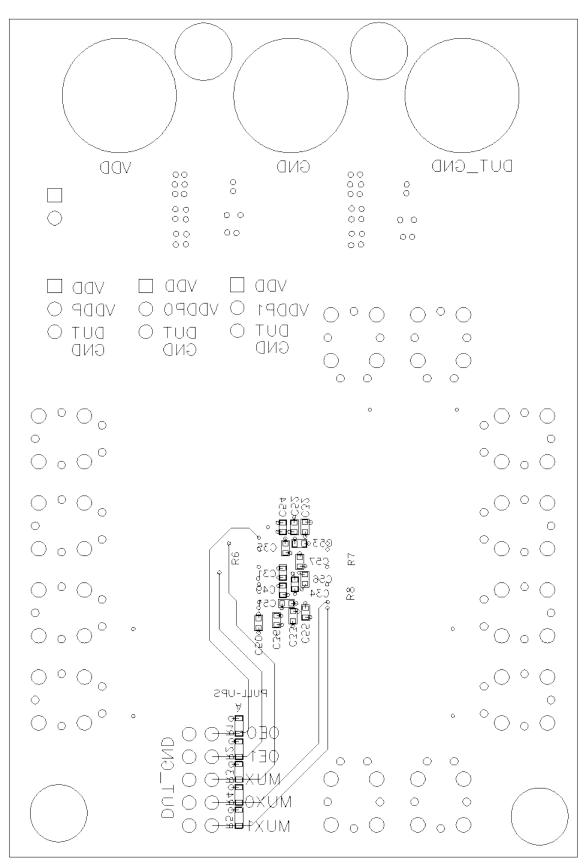


Figure 13. SN65LVCP15 Board Layout: GND (Layer 7)



Board Layout





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As noted in the EVM User's Guide and/or EVM itself, this EVM and/or accompanying hardware may or may not be subject to the Federal Communications Commission (FCC) and Industry Canada (IC) rules.

For EVMs **not** subject to the above rules, this evaluation board/kit/module is intended for use for ENGINEERING DEVELOPMENT, DEMONSTRATION OR EVALUATION PURPOSES ONLY and is not considered by TI to be a finished end product fit for general consumer use. It generates, uses, and can radiate radio frequency energy and has not been tested for compliance with the limits of computing devices pursuant to part 15 of FCC or ICES-003 rules, which are designed to provide reasonable protection against radio frequency interference. Operation of the equipment may cause interference with radio communications, in which case the user at his own expense will be required to take whatever measures may be required to correct this interference.

#### General Statement for EVMs including a radio

User Power/Frequency Use Obligations: This radio is intended for development/professional use only in legally allocated frequency and power limits. Any use of radio frequencies and/or power availability of this EVM and its development application(s) must comply with local laws governing radio spectrum allocation and power limits for this evaluation module. It is the user's sole responsibility to only operate this radio in legally acceptable frequency space and within legally mandated power limitations. Any exceptions to this are strictly prohibited and unauthorized by Texas Instruments unless user has obtained appropriate experimental/development licenses from local regulatory authorities, which is responsibility of user including its acceptable authorization.

## For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant

#### Caution

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

#### FCC Interference Statement for Class A EVM devices

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

#### FCC Interference Statement for Class B EVM devices

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- · Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

#### For EVMs annotated as IC – INDUSTRY CANADA Compliant

This Class A or B digital apparatus complies with Canadian ICES-003.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

#### Concerning EVMs including radio transmitters

This device complies with Industry Canada licence-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

#### Concerning EVMs including detachable antennas

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication.

This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Cet appareil numérique de la classe A ou B est conforme à la norme NMB-003 du Canada.

Les changements ou les modifications pas expressément approuvés par la partie responsable de la conformité ont pu vider l'autorité de l'utilisateur pour actionner l'équipement.

#### Concernant les EVMs avec appareils radio

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes : (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

#### Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante.

Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

## [Important Notice for Users of EVMs for RF Products in Japan]

## This development kit is NOT certified as Confirming to Technical Regulations of Radio Law of Japan

If you use this product in Japan, you are required by Radio Law of Japan to follow the instructions below with respect to this product:

- 1. Use this product in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
- 2. Use this product only after you obtained the license of Test Radio Station as provided in Radio Law of Japan with respect to this product, or
- 3. Use of this product only after you obtained the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to this product. Also, please do not transfer this product, unless you give the same notice above to the transferee. Please note that if you could not follow the instructions above, you will be subject to penalties of Radio Law of Japan.

## Texas Instruments Japan Limited (address) 24-1, Nishi-Shinjuku 6 chome, Shinjuku-ku, Tokyo, Japan

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For Feasibility Evaluation Only, in Laboratory/Development Environments. Unless otherwise indicated, this EVM is not a finished electrical equipment and not intended for consumer use. It is intended solely for use for preliminary feasibility evaluation in laboratory/development environments by technically qualified electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems and subsystems. It should not be used as all or part of a finished end product.

Your Sole Responsibility and Risk. You acknowledge, represent and agree that:

- 1. You have unique knowledge concerning Federal, State and local regulatory requirements (including but not limited to Food and Drug Administration regulations, if applicable) which relate to your products and which relate to your use (and/or that of your employees, affiliates, contractors or designees) of the EVM for evaluation, testing and other purposes.
- 2. You have full and exclusive responsibility to assure the safety and compliance of your products with all such laws and other applicable regulatory requirements, and also to assure the safety of any activities to be conducted by you and/or your employees, affiliates, contractors or designees, using the EVM. Further, you are responsible to assure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard.
- 3. Since the EVM is not a completed product, it may not meet all applicable regulatory and safety compliance standards (such as UL, CSA, VDE, CE, RoHS and WEEE) which may normally be associated with similar items. You assume full responsibility to determine and/or assure compliance with any such standards and related certifications as may be applicable. You will employ reasonable safeguards to ensure that your use of the EVM will not result in any property damage, injury or death, even if the EVM should fail to perform as described or expected.
- 4. You will take care of proper disposal and recycling of the EVM's electronic components and packing materials.

**Certain Instructions.** It is important to operate this EVM within TI's recommended specifications and environmental considerations per the user guidelines. Exceeding the specified EVM ratings (including but not limited to input and output voltage, current, power, and environmental ranges) may cause property damage, personal injury or death. If there are questions concerning these ratings please contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, some circuit components may have case temperatures greater than 60°C as long as the input and output are maintained at a normal ambient operating temperature. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors which can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during normal operation, please be aware that these devices may be very warm to the touch. As with all electronic evaluation tools, only qualified personnel knowledgeable in electronic measurement and diagnostics normally found in development environments should use these EVMs.

Agreement to Defend, Indemnify and Hold Harmless. You agree to defend, indemnify and hold TI, its licensors and their representatives harmless from and against any and all claims, damages, losses, expenses, costs and liabilities (collectively, "Claims") arising out of or in connection with any use of the EVM that is not in accordance with the terms of the agreement. This obligation shall apply whether Claims arise under law of tort or contract or any other legal theory, and even if the EVM fails to perform as described or expected.

Safety-Critical or Life-Critical Applications. If you intend to evaluate the components for possible use in safety critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, such as devices which are classified as FDA Class III or similar classification, then you must specifically notify TI of such intent and enter into a separate Assurance and Indemnity Agreement.

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